

Inverse Sizing and Exploration Based on Diffusion Models and Structural Knowledge

Abstract—Quick and effortless exploration of design spaces is of major importance in the face of rapid development cycles, varying specifications and increasingly complex circuits. It is also well known, that the exploitation of slack in specifications by making adjustments to transistor device sizes can lead to improved yield. We address those challenges by combining two state of the art machine learning approaches to achieve accurate generation of optimal performance points, while also allowing for the possibility to explore nearby sizings that might lead to more robust designs. To this end, a diffusion model is combined with an algorithm, that analyzes the circuit and splits the problem into simpler subproblems. The models are tested on a set of typical operational amplifiers.

I. INTRODUCTION

Since the development of SPICE, the industry accepted method for designing analog circuits has not changed much. While the SPICE models keep becoming more complex [1], the approach of manual device tuning persists [2]. Key challenges of making analog CAD tools useful in practice are robustness, ease of use and applicability to a high range of use cases. All those aspects are not easy to grasp on a fundamental level. On the other hand, machine learning approaches excel in modeling nonlinear black box phenomena. Their combination with already existing conventional techniques has a high potential to bridge remaining gaps, that prevent the adoption of tools in industry.

Analog design is inherently an inverse problem. While the calculation of performances, yield etc., is satisfactorily possible via simulation, the inverse, i.e. getting a circuit with optimal parametrization requires experience, trial and error and complex numerical routines. As shown in previous works [3], [4], machine learning (ML) methods can be used to accurately reproduce sizings on (pareto) optimal fronts. Furthermore, it has been shown [5] that diffusion models are well adaptable to the inverse sizing problem. Other ML based works attempted to solve this same problem. In [6], artificial neural networks (ANNs) are used to guess circuit sizings, utilizing only one ANN for modeling an entire netlist, leading to a higher learning task complexity and thus large sample sizes (in [6] 16600 or roughly $16 - 160x$ sample sizes used in this work) are required to learn the inverse problem within a smaller performance range. In [7], the problem is broken down into smaller tasks, and one ANN is trained to sequentially size a single device, in the same vein as [3], feeding the outputs of the previous ANNs to the input of the next, producing

a cascade of networks that can be sorted in different ways, until an optimal order is found. The drawback is that for more complex circuits of e.g. 15 devices, optimally ordering the ANNs for sizing leads to a complexity of $15!$.

Other works follow the traditional approach of tackling the direct sizing problem, treating it as an optimization problem [8]–[11]. Reinforcement learning was also studied, with [?], [12], [13] replacing the optimizer with an artificial neural network (ANN), leading to improvements in prediction speed, accuracy, and scalability. However, to the best of our knowledge, none of them show strengths in all four categories, speed, accuracy, sample efficiency and exploration.

In this work, we aim for a combination of all those virtues by applying denoising diffusion probabilistic models (DDPM) to the sizing of OpAmps, utilizing the approach in [3] of subdividing the circuits into simpler structures, which has shown high accuracy for low sample sizes. DDPMs have proven their potential for generating strongly varied, but realistic results in other fields, OpenAi’s DALL-E and Stable Diffusion being among the most prominent examples. [5] proved these model’s efficacy in the inverse sizing problem.

Unlike most machine learning models, DDPMs can suggest different sizings for the same problem by repeatedly sampling them. As shown in Section IV, this approach to the inverse problem can produce a more varied set of possible sizings, which is very helpful when exploring sizing options in the vicinity of performance optima. This work contributes a machine learning approach that:

- can suggest valid sizings with resulting performance in the vicinity of the required metrics, allowing for exploration of sizings while still fulfilling specifications
- is highly data efficient
- has an accurate expectation of the generated sizings
- generates sizing solutions at push-button speed

In section II, we provide an overview of the proposed method and its connection to structural analysis. In sec. ??, we describe the sizing process in detail. We conclude with a presentation of results for two OpAmps.

II. FROM STRUCTURAL ANALYSIS TO CIRCUIT SIZING VIA MACHINE LEARNING

A. Basics of Structural and Functional Blocks

As detailed in [3], the method relies on the decomposition of circuits into subcircuits, which we call structural building blocks. While the structure of the blocks is defined by their topology, i.e. the devices and their interconnections, we

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The correlation between the forward and reverse process to noise and denoise images can be seen in Fig 4.

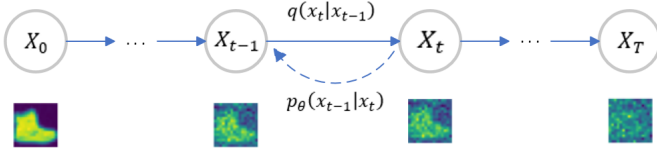


Fig. 4: Correlation between forward and reverse

3) *Sampling Process*: Finally, after the model is trained, the sampling process is used to generate new data. The model learned to reconstruct the original data, and so by giving it pure Gaussian noise it tries to reconstruct data. Except this time, there is no actual data in the first place, marking this a form of generative AI.

It was shown by [5] that DDPMs produce interesting results when applied to the inverse sizing problem. In this work, a similar implementation is considered, with a cosine schedule for β and classifier-free guidance [?], but with 2 key differences:

- instead of predicting the noise ϵ , the implemented model predicts a velocity equation v which has been shown to enable a true signal-to-noise ratio of 0 at the last timestep T , removing an important discrepancy between training and inference [?];
- the backbone of the model implemented here is a transformer, with an architecture similar to [?], as opposed to the simple multi-layer perceptrons implemented by [5]. To predict a more complex value in v a stronger architecture was required.

A. Results

IV. CONCLUSION

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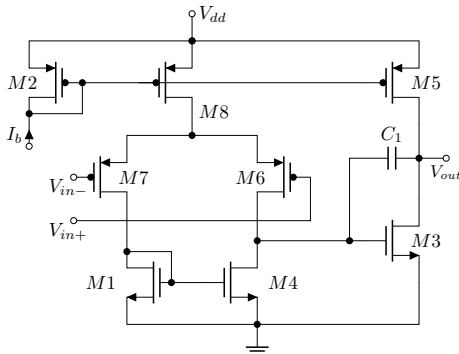


Fig. 5: Miller OpAmp